# OP \$40.00 1124

## PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Paul Wallner	10/25/2005
Yukio Fukuzo	11/08/2005
Christian Sichert	11/04/2005
Paul Schmolz	12/15/2005

### **RECEIVING PARTY DATA**

Name:	Infineon Technologies AG		
Street Address:	StMartin-Str. 53		
City:	Munich		
State/Country:	GERMANY		
Postal Code:	81669		

### PROPERTY NUMBERS Total: 1

	Property Type	Number
Ш	Application Number:	11242149

### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	3001.0023C
NAME OF SUBMITTER:	Patrick J. Finnan

PATENT REEL: 016980 FRAME: 0484

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Total Attachments: 4 source=Executed Assign#page1.tif source=Executed Assign#page2.tif source=Executed Assign#page3.tif source=Executed Assign#page4.tif

> PATENT REEL: 016980 FRAME: 0485

### ASSIGNMENT

For good and valuable consideration, WE, Paul Wallner, a citizen of Germany, residing at Irmingardweg 7a, 83209 Prien, Germany; Yukio Fukuzo, a citizen of Japan, residing at Geibelstr. 7, 81679 München, Germany; Christian Sichert, a citizen of Germany, residing at Schanderlweg 12, 81827 München, Germany; and Paul Schmölz, a citizen of Austria, residing at Breisacher Str. 13, 81667 München, Germany, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to Infineon Technologies AG, a corporation, organized and existing under the laws of Germany, having its principal place of business at St.-Martin-Str. 53, 81669 Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and filed herewith, entitled:

# SEMICONDUCTOR MEMORY CHIP

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, it successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE: DATE: 2005-10-25

INFINEON REF NO. 13624 O.C. REF NO. 3001.0023C

SIGNATURE:	Jubio Ju Yukio Fukuzo	buzo	DATE: A. N. V. 2005	
SIGNATURE:	Christian Sichert		DATE:	
SIGNATURE:	Paul Schmölz		DATE:	

INFINEON REF NO. 13624 O.C. REF NO. 3001.0023C

SIGNATURE:	Yukio Fukuzo		DATE:	
SIGNATURE:	Christian Sichert	,	DATE:	04-Nov-2005
SIGNATURE:	Paul Schmölz		DATE:	·

INFINEON REF NO. 13624 O.C. REF NO. 3001.0023C

SIGNATURE:	Yukio Fukuzo	_ DATE;
SIGNATURE:	Christian Sichert	DATE:
SIGNATURE:	Paul Schmölz	DATE: 200 J- 12 -15

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PATENT REEL: 016980 FRAME: 0489